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Vishay General Semiconductor

AUTOMOTIVE

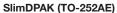
RoHS

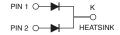
COMPLIANT

HALOGEN FREE

Surface-Mount ESD Capability Rectifier







LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	2 x 2 A			
V_{RRM}	100 V, 200 V, 400 V, 600 V			
I _{FSM}	36 A			
V_F at $I_F = 2 \text{ A } (T_A = 125 \text{ °C})$	0.92 V			
T _J max.	175 °C			
Package	SlimDPAK (TO-252AE)			
Circuit configuration	Common cathode			

FEATURES

- Very low profile typical height of 1.3 mm
- Ideal for automated placement
- Oxide planar chip junction
- · Low forward voltage drop
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both industry and automotive applications.

MECHANICAL DATA

Case: SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102, M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	SE40PWBC	SE40PWDC	SE40PWGC	SE40PWJC	UNIT	
Device marking code		SE40PWBC	SE40PWDC	SE40PWGC	SE40PWJC		
Maximum repetitive peak reverse voltage		100	200	400	600	V	
Maximum average forward rectified current (fig. 1) per device per diode I _{F(AV)} (1) 4 2					Α		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	36				Α	
Operating junction and storage temperature range	T _J , T _{STG}		-55 to	+175		°C	

Note

(1) With infinite heatsink



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum Instantaneous forward voltage	I _F = 1.0 A	T 05.00		0.94	-	
	I _F = 2.0 A	V _F (1)	1.01	1.10	V	
	I _F = 1.0 A	T _A = 125 °C	VF(')	0.84	-	V
	I _F = 2.0 A			0.92	1.01	
Deverage everyont	Datad V	T _A = 25 °C	I _R ⁽²⁾	=	10	μΑ
Reverse current	Rated V _R	T _A = 125 °C		12	150	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	1500	-	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	14	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 $\,\%$ duty cycle

(2) Pulse test: pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL SE40PWBC SE40PWDC SE40PWGC SE40PWJC UNIT					
Typical thermal resistance per device	R ₀ JA (1)(2)	63			°C/W	
Typical thermal resistance per device	R _{0JM} (3)	2.5				C/VV

Notes

- $^{(1)}$ The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ junction to ambient
- (3) Mounted on infinite heat sink; thermal resistance R_{0JM} junction-to-mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$ unless otherwise noted)						
STANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS VALUE						
AEC-Q101-001 Human body model (contact mode) $C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$ V_C H3B $> 8 \text{ kV}$						

ORDERING INFORMATION (Example)							
PREFERRED P/N UNIT WEIGHT (g) PREFERRED PACKAGE CODE BASE QUANTITY DELIVERY MODE							
SE40PWJC-M3/I	0.20	I	4500	13" diameter plastic tape and reel			
SE40PWJCHM3/I (1)	0.20	I	4500	13" diameter plastic tape and reel			

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

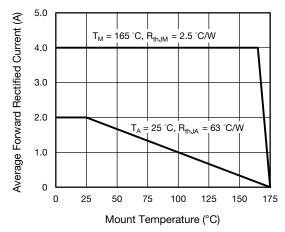


Fig. 1 - Maximum Forward Current Derating Curve

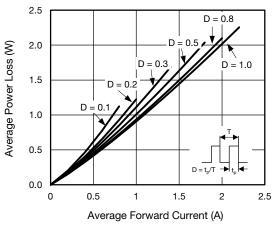


Fig. 2 - Forward Power Loss Characteristics

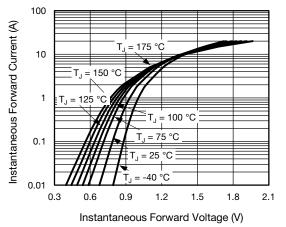


Fig. 3 - Typical Instantaneous Forward Characteristics

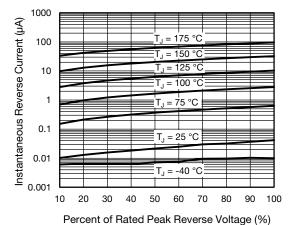


Fig. 4 - Typical Reverse Leakage Characteristics

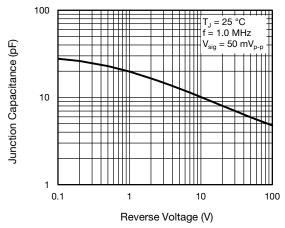


Fig. 5 - Typical Junction Capacitance

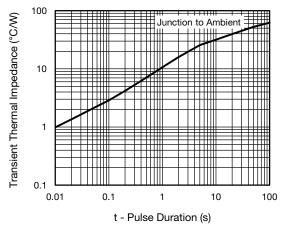


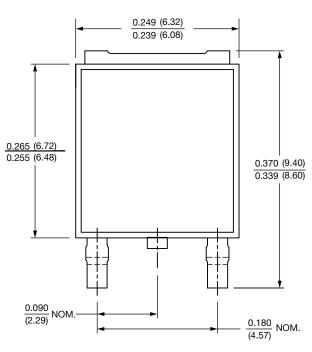
Fig. 6 - Typical Transient Thermal Impedance

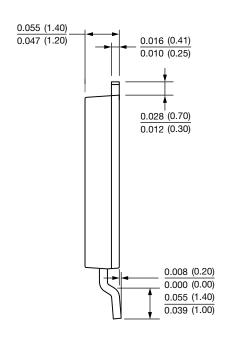


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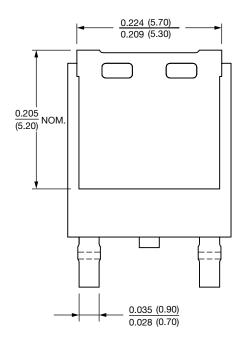
PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

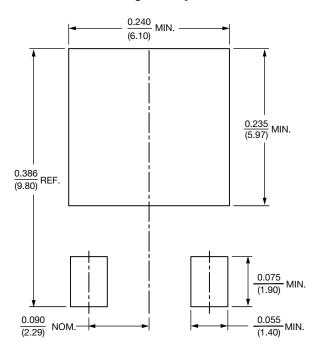
SlimDPAK (TO-252AE)





Mounting Pad Layout







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